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## \*BIBDATASHEET\*

CONFIRMATION NO. 2265

Bib Data Sheet

SERIAL NUMBER 10/662,541	FILING DATE 09/15/2003 RULE	CLASS 257	GROUP ART UNIT 2815	ATTORNEY DOCKET NO. SC12481TK
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## APPLICANTS

Chu-Chung Lee, Round Rock, TX;

Fuaida Harun, Selangor, MALAYSIA;  
 Kevin J. Hess, Austin, TX; Lan Chu Tan, Selangor, MALAYSIA;  
 Cheng Choi Yong, Selangor, MALAYSIA;

jbe

## \*\* CONTINUING DATA \*\*\*\*\*

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## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

MALAYSIA PI20031227 04/02/2003 (Not in the file)

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 12/18/2003

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	TX	DRAWING 2	CLAIMS 28 16	CLAIMS 4 2
Verified and Acknowledged	<i>John M. Lee</i> Examiner's Signature	Initials			

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 7700 WEST PARMER LANE MD:TX32/PL02  
 AUSTIN , TX  
 78729

## TITLE

Integrated circuit die having a copper contact and method therefor

		<input type="checkbox"/> All Fees
FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT	<input type="checkbox"/> 1.16 Fees ( Filing )
		<input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )



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<b>** CONTINUING DATA</b> <i>Ybe</i>					
<b>** FOREIGN APPLICATIONS</b> <i>Ybe</i> MALAYSIA PI20031227 04/02/2003 (Not in the file)					
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 12/18/2003</b>					
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<b>ADDRESS</b> 23125 FREESCALE SEMICONDUCTOR, INC. <b>LAW DEPARTMENT</b> 7700 WEST PARMER LANE MD:TX32/PL02 AUSTIN , TX 78729					
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